Bipolar Transistors Silicon PNP Triple-Diffused Type

# 2SA2034

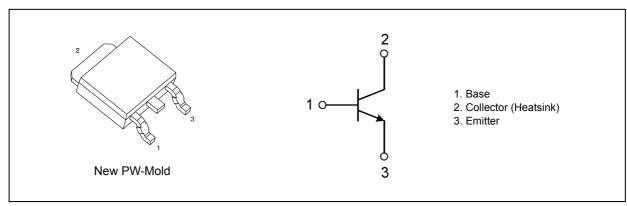
#### 1. Applications

High-Voltage Switching

#### 2. Features

- (1) High collector voltage:  $V_{CEO} = -400 \text{ V} \text{ (min)}$
- (2) High-speed switching:  $t_f = 0.3 \ \mu s \ (max) \ (I_C = -1.0 \ A)$

#### 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics			Symbol	Rating	Unit
Collector-base voltage			V <sub>CBO</sub>	-400	V
Collector-emitter voltage			V <sub>CEO</sub>	-400	]
Emitter-base voltage			V <sub>EBO</sub>	-7	
Collector current (DC)		(Note 1)	Ι <sub>C</sub>	-2	A
Collector current (pulsed)		(Note 1)	I <sub>CP</sub>	-4	]
Base current			Ι <sub>Β</sub>	-1	]
Collector power dissipation	(T <sub>a</sub> = 25 °C)		P <sub>C</sub>	1	W
Collector power dissipation	(T <sub>c</sub> = 25 °C)		P <sub>C</sub>	15	1
Junction temperature			Tj	150	°C
Storage temperature			T <sub>stg</sub>	-55 to 150	]

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the junction temperature does not exceed 150 °C.

Rev.1.0

#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Junction-to-case thermal resistance	R <sub>th(j-c)</sub>	8.33	°C/W
Junction-to-ambient thermal resistance	R <sub>th(j-a)</sub>	125	

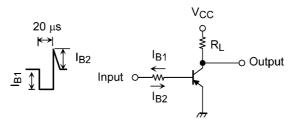
#### 6. Electrical Characteristics

#### 6.1. Static Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -400 V, I <sub>E</sub> = 0 A	_	_	-10	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -7 V, I <sub>C</sub> = 0 A			-1	
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> = -10 mA, I <sub>B</sub> = 0 A	-400	_		V
DC current gain	h <sub>FE(1)</sub>	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -1 mA	80	_	_	_
	h <sub>FE(2)</sub>	V <sub>CE</sub> = -5 V, I <sub>C</sub> = -0.1 A	80	_	240	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -0.5 A, I <sub>B</sub> = -0.1 A	_	_	-1.0	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> = -0.5 A, I <sub>B</sub> = -0.1 A	_	_	-1.5	

#### 6.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25$ °C)

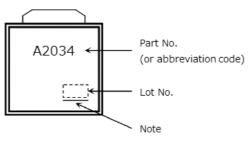
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Switching time (rise time)	t <sub>r</sub>	See Fig. 6.2.1	_	—	0.3	μS
Switching time (storage time)	t <sub>stg</sub>	V <sub>CC</sub> ≈ -200 V, R <sub>L</sub> = 200 Ω, I <sub>B1</sub> = -0.2 A, I <sub>B2</sub> = 0.2 A,	_	—	2.5	μS
Switching time (fall time)	t <sub>f</sub>	י <sub>B1</sub> – -0.2 ה, י <sub>B2</sub> – 0.2 ה,	_		0.3	μS



Duty cycle  $\leq 1\%$ 

Fig. 6.2.1 Switching Time Test Circuit

#### 7. Marking (Note)

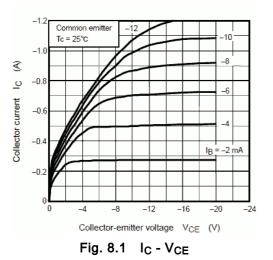


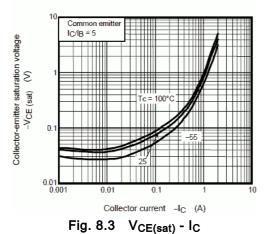


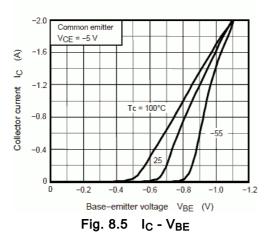
Note: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the

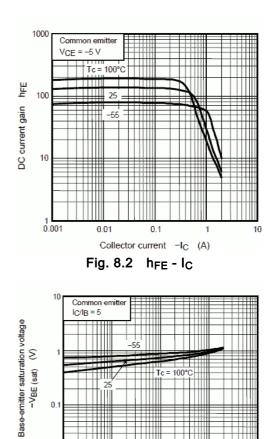
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)









0.01

0.01

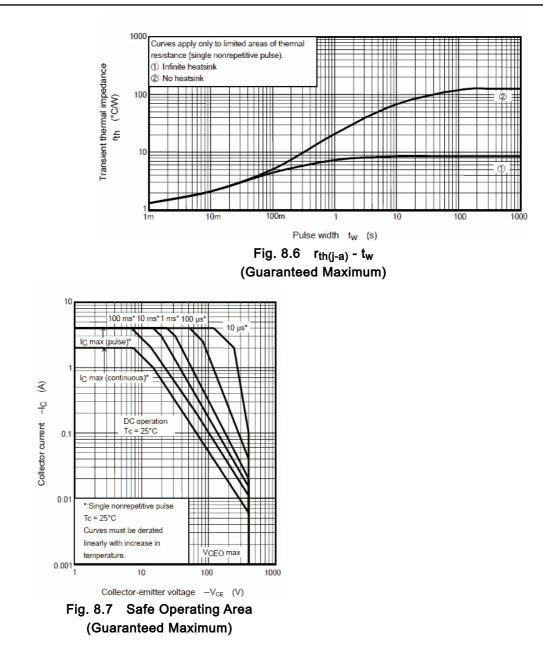
0.1

Collector current -I<sub>C</sub> (A)

Fig. 8.4 V<sub>BE(sat)</sub> - I<sub>C</sub>

10



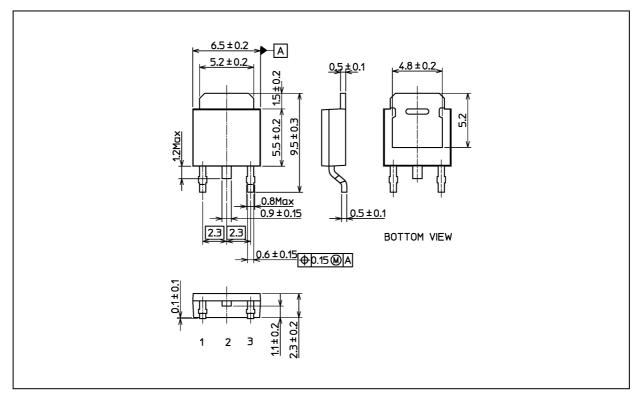


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### 2SA2034

#### Package Dimensions

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7J1S
Nickname: New PW-Mold

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